Lattice Semiconductor Corporation - LC5768VG-12F484I Datasheet

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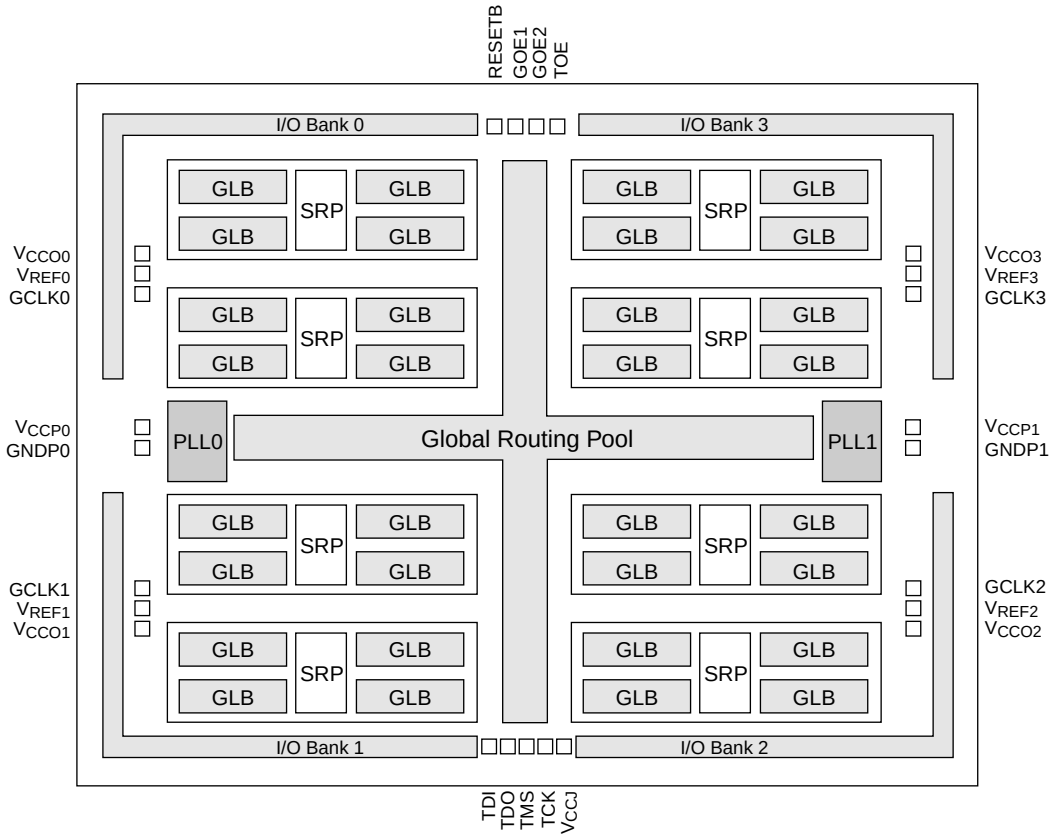
Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details	
Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	12 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	24
Number of Macrocells	768
Number of Gates	-
Number of I/O	304
Operating Temperature	-40°C ~ 105°C (TJ)
Mounting Type	Surface Mount
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc5768vg-12f484i

Figure 1. Functional Block Diagram



Overview

The ispMACH 5000VG devices consist of multiple SuperWIDE 68-input, 32-macrocell Generic Logic Blocks (GLBs) interconnected by a tiered routing system. Figure 1 shows the functional block diagram of the ispMACH 5000VG. Groups of four GLBs, referred to as segments, are interconnected via a Segment Routing Pool (SRP). Segments are interconnected via the Global Routing Pool (GRP.) Together the GLBs and the routing pools allow designers to create large designs in a single device without compromising performance.

Each GLB has 68 inputs coming from the SRP and contains 163 product terms. These product terms form groups of five product term clusters, which feed the PT sharing array or the macrocell directly. The ispMACH 5000VG allows up to 160 product terms to be connected to a single macrocell via the product term expanders and PT Sharing Array.

The macrocell is designed to provide flexible clocking and control functionality with the capability to select between global, product term and block-level resources. The outputs of the macrocells are fed back into the switch matrices and, if required, the sysIO cell.

All I/Os in the ispMACH 5000VG family are sysIOs, which are split into four banks. Each bank has a separate I/O power supply and reference voltage. The sysIO cells allow operation with a wide range of today's emerging interface standards. Within a bank, inputs can be set to a variety of standards, providing the reference voltage requirements of the chosen standards are compatible. Within a bank, the outputs can be set to differing standards, providing the I/O power supply voltage and the reference voltage requirements of the chosen standard are compatible. Support for this wide range of standards allows designers to achieve significantly higher board-level performance compared to the more traditional LVCMOS standards.

Figure 3. Macrocell Slice

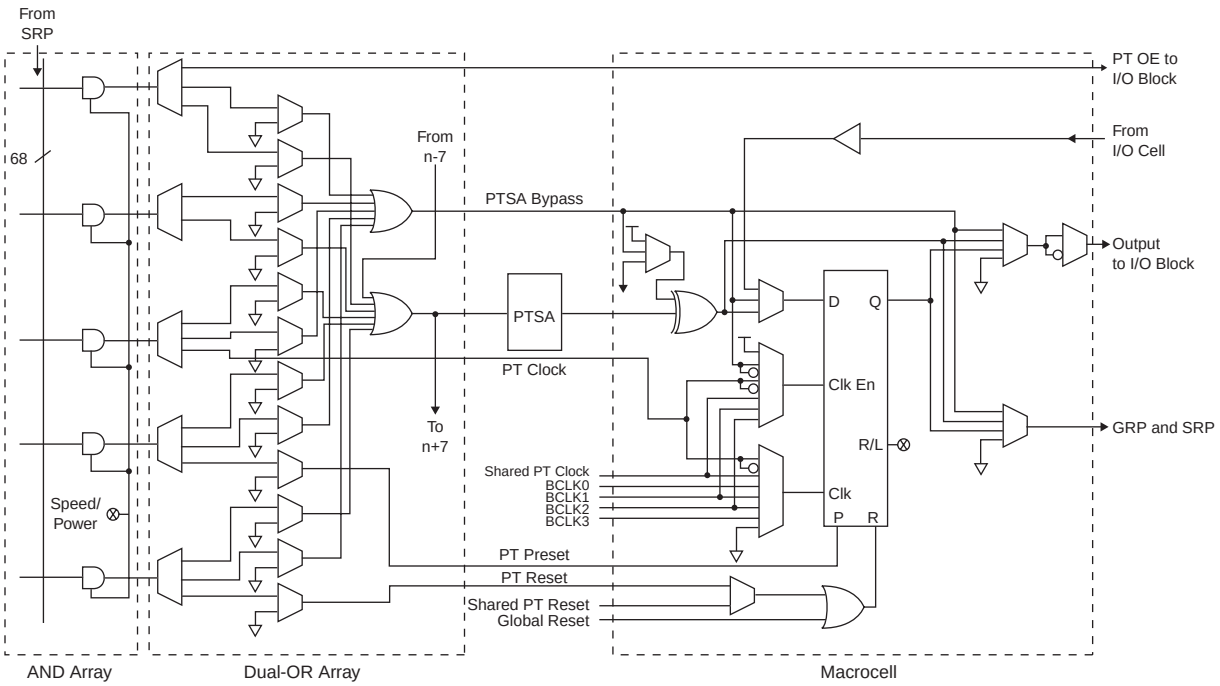
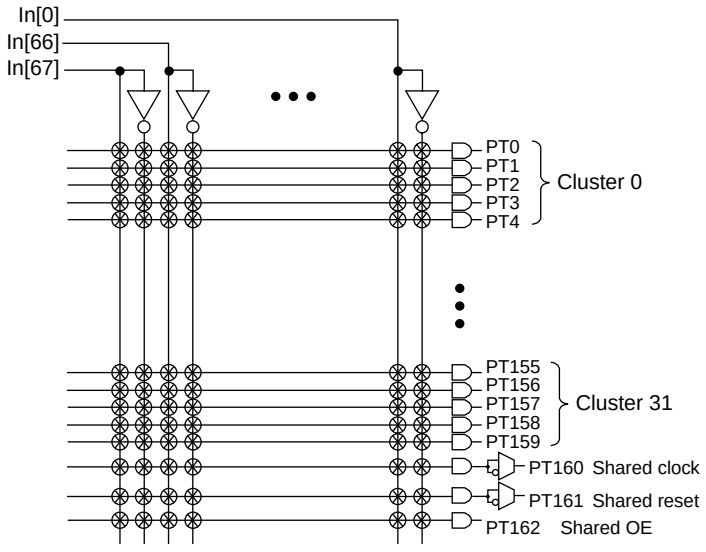


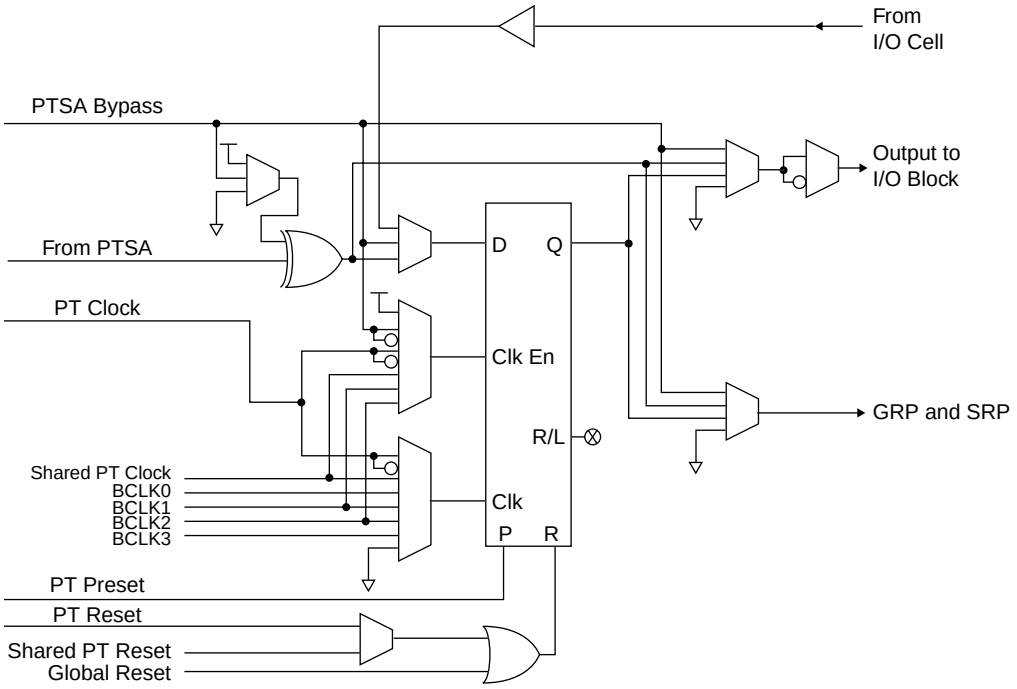
Figure 4. AND-Array



Note:
⊗ Indicates programmable fuse.

ing with PT0. There is one product term cluster for every macrocell in the GLB. In addition to the three control product terms, the first, third, fourth and fifth product terms of each cluster can be used as a PTOE (output macrocells only), PT Clock, PT Preset and PT Reset, respectively. Figure 4 is a graphical representation of the AND-Array.

Figure 7. Macrocell



I/O Cell

The I/O cell of the ispMACH 5000VG device provides a high degree of flexibility. It includes the sysIO feature and an enhanced output enable MUX for optimal performance both on- and off-chip. The sysIO feature allows I/O cells to be configured to different I/O standards, drive strengths and slew rates. The enhanced output enable MUX provides up to 14 different output enable choices per I/O cell.

The I/O cell contains an output enable (OE) MUX, a programmable tri-state output buffer, a programmable input buffer, a programmable pull-up resistor, a programmable pull-down resistor and a programmable bus-keeper latch. The I/O cell receives its input from its associated macrocell. The I/O cell has a feedback line to its associated macrocell and a direct path to the GRP and SRP.

The output enable (OE) MUX selects the OE signal per I/O cell. The inputs to the OE MUX are the four Shared PTOE signals, PTOE and the two GOE signals. The OE MUX also has the ability to choose either the true or inverse of each of these signals. The output of the OE MUX goes through a logical AND with the TOE signal to allow easy tri-stating of the outputs for testing purposes.

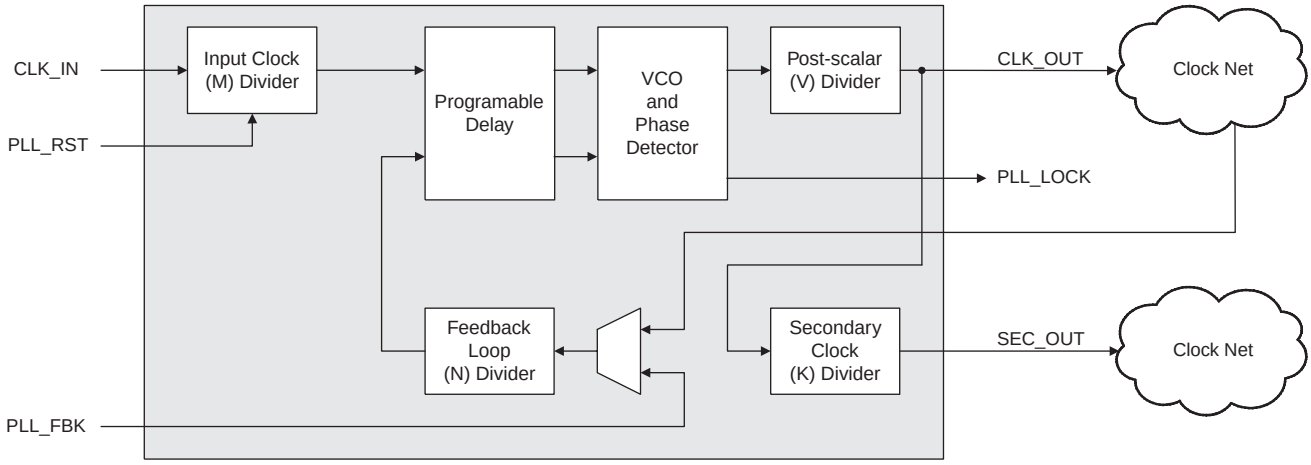
The four shared PTOE signals are derived from PT163 of each GLB in the segment. The PTOE signal is derived from the first product term in each macrocell cluster, which is directly routed to the OE MUX. Therefore, every I/O cell can have a different OE signal. Figure 8 is a graphical representation of the I/O cell.

sysCLOCK PLL

The sysCLOCK PLL circuitry consists of Phase-Lock Loops (PLLs) and the various dividers, reset and feedback signals associated with the PLLs. This feature gives the user the ability to synthesize clock frequencies and generate multiple clock signals for routing within the device. Furthermore, it can generate clock signals that are deskewed either at the board level or the device level.

The ispMACH 5000VG devices provide two PLL circuits. PLL0 receives its clock inputs from GCLK 0 and provides outputs to CLK 0 (CLK 1 when using the secondary clock). PLL1 operates with signals from GCLK 3 and CLK 3 (CLK 2 when using the secondary clock). The PLL outputs (CLK_OUT) are routed via a dedicated net to a dedicated pad. Further the buffers at these dedicated pads are regular I/O buffers that can select either the I/O macrocell or the CLK_OUT (CLK_OUT0/CLK_OUT1) signal. The CLK_OUT nets are not routed through the GRP. Additionally, there are two sets of signals used for external control. Each PLL has a set of PLL_RST, PLL_FBK and PLL_LOCK signals. Figure 10 shows the ispMACH 5000VG PLL block diagram.

Figure 10. PLL Block Diagram



In order to facilitate the multiply and divide capabilities of the PLL, each PLL has dividers associated with it: M, N and K. The M divider is used to divide the clock signal, while the N divider is used to multiply the clock signal. The K divider is only used when a secondary clock output is needed. This divider divides the primary clock output and feeds to a separate global clock net. The V divider is used to provide lower frequency output clocks, while maintaining a stable, high frequency output from the PLL's VCO circuit.

The PLL also has a delay feature that allows the output clock to be advanced or delayed to improve set-up and clock-to-out times for better performance. This operates by inserting delay on the input or feedback lines in 0.5ns increments from 0 to 3.5ns. For more information on the PLL, please refer to Technical Note TN1003: *ispMACH 5000VG PLL Usage Guidelines* .

Power Management

The ispMACH 5000VG devices provide unique power management controls. The devices have two power settings, high power and low power, on a per node basis. Low power consumption is approximately 50% of high power consumption with a timing delay adder (tLP) to the routing delay of the low power node. Each node can be configured as either high power or low power. However, care should be taken when sharing product terms between nodes with different power settings.

The ispMACH 5000VG devices also have a power-off feature for unused product terms. By default, any product term that is not used is configured as such. This allows the device to operate at minimal power consumption without affecting the timing of the design. For more information on power management, please refer to Technical Note TN1002: *Power Estimation in ispMACH 5000VG Devices*.

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition		Min	Typ	Max	Units
I_{IL}, I_{IH}[1]	Input or I/O Leakage Current	$0V \le V_{IN} \le V_{IH}$ (MAX)		—	—	+/-10	µA
I_{PU}[2]	I/O Weak Pull-up Resistor Current	$0 \le V_{IN} \le 0.7\ V_{CCO}$	V_{CCO} = 3.3	-30	—	-150	µA
			V_{CCO} = 2.5	-20	—	-150	µA
			V_{CCO} = 1.8	-10	—	-150	µA
I_{PD}[2]	I/O Weak Pull-down Resistor Current	V_{IL} (MAX) $\le V_{IN} \le V_{IH}$ (MAX)		30	—	150	µA
I_{BHLS}[2]	Bus Hold Low Sustaining Current	$V_{IN} = V_{IL}$ (MAX)		30	—	—	µA
I_{BHHS}[2]	Bus Hold High Sustaining Current	$V_{IN} = 0.7\ V_{CCO}$	V_{CCO} = 3.3	-30	—	—	µA
			V_{CCO} = 2.5	-20	—	—	µA
			V_{CCO} = 1.8	-10	—	—	µA
I_{BHLO}[2]	Bus Hold Low Overdrive Current	$0V \le V_{IN} \le V_{IH}$ (MAX)		—	—	150	µA
I_{BHHO}[2]	Bus Hold High Overdrive Current	$0V \le V_{IN} \le V_{IH}$ (MAX)		—	—	-150	µA
I_{CC}[3, 4, 5]	Operating Power Supply Current	V_{CC} = 3.3V		—	380	—	mA
V_{BHT}	Bus Hold Trip Points			V_{IL} (MAX)	—	V_{IH} (MIN)	V
C_1	I/O Capacitance[3]	V_{CC} = 3.3V, V_{IO} = 0 to V_{IH} (MAX)		—	10	—	pf
		V_{CCO} = 3.3V, 2.5, 1.8, 1.5					
C_2	Clock Capacitance[3]	V_{CC} = 3.3V, V_{IO} = 0 to V_{IH} (MAX)		—	10	—	pf
		V_{CCO} = 3.3V, 2.5, 1.8, 1.5					
C_3	Global Input Capacitance[3]	V_{CC} = 3.3V, V_{IO} = 0 to V_{IH} (MAX)		—	10	—	pf
		V_{CCO} = 3.3V, 2.5, 1.8, 1.5					

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. Only available for LVCMOS and LVTTL standards.
3. T_A = 25°C, f = 1.0MHz.
4. Device configured with 16-bit counters.
5. I_{CC} varies with specific device configuration and operating frequency.

ispMACH 51024VG External Switching Characteristics

Over Recommended Operating Conditions

Parameter	Description[1,2,3]	-5		-75		-10		-12		Units
		Min	Max	Min	Max	Min	Max	Min	Max	
t_{PD}	Data propagation delay, 5-PT bypass	—	5.0	—	7.5	—	10.0	—	12.0	ns
t_{PD_PTSA}	Data propagation delay, intrasegment path	—	6.0	—	9.0	—	11.5	—	13.5	ns
t_{PD_GLOBAL}	Data propagation delay, intersegment path	—	6.5	—	9.75	—	13.0	—	16.0	ns
t_S	GLB register setup time before clock, 5-PT bypass	3.0	—	5.0	—	7.5	—	9.3	—	ns
t_{S_PTSA}	GLB register setup time before clock	3.0	—	6.0	—	8.5	—	10.0	—	ns
t_{SIR}	GLB register setup time before clock, input register path	2.8	—	3.0	—	4.0	—	5.0	—	ns
t_H	GLB register hold time before clock, 5-PT bypass	0.0	—	0.0	—	0.0	—	0.0	—	ns
t_{H_PTSA}	GLB register hold time before clock	0.0	—	0.0	—	0.0	—	0.0	—	ns
t_{HIR}	GLB register hold time before clock, input reg. path	0.0	—	0.0	—	0.0	—	0.0	—	ns
t_{CO}	GLB register clock-to-output delay	—	4.4	—	5.0	—	6.0	—	7.0	ns
t_R	External reset pin to output delay	—	6.5	—	9.0	—	10.0	—	10.9	ns
t_{RW}	External reset pulse duration	4.0	—	6.0	—	8.0	—	9.5	—	ns
$t_{LPTOE/DIS}$	Input to output local product term output enable/disable	—	7.0	—	9.75	—	11.5	—	13.4	ns
$t_{SPTOE/DIS}$	Input to output segment product term output enable/disable	—	8.0	—	11.25	—	17.5	—	20.4	ns
$t_{GOE/DIS}$	Global OE input to output enable/disable	—	6.2	—	7.5	—	8.85	—	10.0	ns
t_{CW}	Global clock width, high or low	1.6	—	2.75	—	3.6	—	4.3	—	ns
t_{GW}	Global gate width low (for low transparent) or high (for high transparent)	1.8	—	2.75	—	3.6	—	4.3	—	ns
t_{WIR}	Input register clock width, high or low	1.8	—	2.75	—	3.6	—	4.3	—	ns
t_{SKEW}	Clock-to-out skew, block level	—	0.25	—	0.35	—	0.45	—	0.55	ns
	Clock-to-out skew, segment level	—	0.4	—	0.5	—	0.6	—	0.7	ns
f_{MAX}[4]	Clock frequency with internal feedback	178.6	—	117.0	—	87.0	—	73.0	—	MHz
f_{MAX} (Ext.)	Clock frequency with external feedback, $1/ (t_{S\_PTSA} + t_{CO})$	135.1	—	90.9	—	69.0	—	58.8	—	MHz
f_{MAX} (Tog.)	Clock frequency max Toggle	312.5	—	181.0	—	138.0	—	116.0	—	MHz

Timing v.1.10

1. Timing numbers are based on default LVCMOS 3.3 I/O Buffers. Use timing adjusters provided to calculate timing for other standards.
2. Measured using standard switching circuit, assuming segment and global routing loading of 1, worst case PTSA loading and 1 output switching.
3. Pulse widths and clock widths less than minimum will cause unknown behavior.
4. Standard 16-bit counter using SRP feedback.

ispMACH 5768VG Timing Adders

Adder Type	Base Parameter	Description	-5		-75		-10		-12		Units
			Min	Max	Min	Max	Min	Max	Min	Max	
t_{BLA}	t_{ROUTE}	GLB Loading Adder	—	0.0	—	0.0	—	0.0	—	0.0	ns
t_{EXP}	t_{PTSA}	PT Expander Adder	—	1.5	—	2.0	—	2.5	—	2.5	ns
t_{LP}	t_{ROUTE}	Low Power Adder	—	1.5	—	1.5	—	1.5	—	1.5	ns
t_{IOI} Input Adders											
LVCMOS18_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using LVCMOS1.8 standard	—	0.90	—	0.90	—	0.90	—	0.90	ns
LVCMOS25_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using LVCMOS2.5 standard	—	0.15	—	0.15	—	0.15	—	0.15	ns
LVCMOS33_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using LVCMOS3.3 standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVTTL	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using LVTTL standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
PCI_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using PCI standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
PCI_X_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using PCI_X standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
AGP_1X_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using AGP-1X standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
SSTL3_I_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using SSTL3_I standard	—	1.00	—	1.00	—	1.00	—	1.00	ns
SSTL3_II_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using SSTL3_II standard	—	1.00	—	1.00	—	1.00	—	1.00	ns
SSTL2_I_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using SSTL2_I standard	—	1.00	—	1.00	—	1.00	—	1.00	ns
SSTL2_II_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using SSTL2_II standard	—	1.00	—	1.00	—	1.00	—	1.00	ns
CTT33_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using CTT3.3 standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
CTT25_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using CTT2.5 standard	—	0.15	—	0.15	—	0.15	—	0.15	ns
HSTL_I_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using HSTL_I standard	—	1.25	—	1.25	—	1.25	—	1.25	ns
HSTL_III_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using HSTL_III standard	—	1.25	—	1.25	—	1.25	—	1.25	ns
GTL+_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using GTL+ standard	—	1.50	—	1.50	—	1.50	—	1.50	ns
LVDS_in	t_{GCLK_IN}	Using LVDS standard	—	1.70	—	1.70	—	1.70	—	1.70	ns
LVPECL_in	t_{GCLK_IN}	Using LVPECL standard	—	2.10	—	2.10	—	2.10	—	2.10	ns
t_{IOO} Output Adders											
LVCMOS18_4mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 1.8V & 4mA Buffer	—	3.00	—	3.00	—	3.00	—	3.00	ns
LVCMOS18_5mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 1.8V & 5.33mA Buffer	—	2.50	—	2.50	—	2.50	—	2.50	ns
LVCMOS18_8mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 1.8V & 8mA Buffer	—	1.85	—	1.85	—	1.85	—	1.85	ns

Note: Open drain timing is the same as corresponding LVCMOS timing.

Timing v.1.20

ispMACH 5768VG Timing Adders (Continued)

Adder Type	Base Parameter	Description	-5		-75		-10		-12		Units
			Min	Max	Min	Max	Min	Max	Min	Max	
LVCMOS18_12mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 1.8V & 12mA Buffer	—	1.35	—	1.35	—	1.35	—	1.35	ns
LVCMOS25_4mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 2.5V & 4mA Buffer	—	1.50	—	1.50	—	1.50	—	1.50	ns
LVCMOS25_5mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 2.5V & 5.33mA Buffer	—	1.25	—	1.25	—	1.25	—	1.25	ns
LVCMOS25_8mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 2.5V & 8mA Buffer	—	0.70	—	0.70	—	0.70	—	0.70	ns
LVCMOS25_12mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 2.5V & 12mA Buffer	—	0.50	—	0.50	—	0.50	—	0.50	ns
LVCMOS25_16mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 2.5V & 16mA Buffer	—	0.25	—	0.25	—	0.25	—	0.25	ns
LVCMOS33_4mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 3.3V & 4mA Buffer	—	1.50	—	1.50	—	1.50	—	1.50	ns
LVCMOS33_5mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 3.3V & 5.33mA Buffer	—	1.25	—	1.25	—	1.25	—	1.25	ns
LVCMOS33_8mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 3.3V & 8mA Buffer	—	0.40	—	0.40	—	0.40	—	0.40	ns
LVCMOS33_12mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 3.3V & 12mA Buffer	—	0.10	—	0.10	—	0.10	—	0.10	ns
LVCMOS33_16mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 3.3V & 16mA Buffer	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVCMOS33_20mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 3.3V & 20mA Buffer	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVTTL	t_{BUF}, t_{EN}, t_{DIS}	Output configured as LVTTL Buffer	—	0.0	—	0.0	—	0.0	—	0.0	ns
Slow Slew	t_{BUF}, t_{EN}	Output configured for slow slew rate	—	1.50	—	1.50	—	1.50	—	1.50	ns
PCI_out	t_{BUF}, t_{EN}, t_{DIS}	Using PCI standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
PCI_X_out	t_{BUF}, t_{EN}, t_{DIS}	Using PCI-X standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
AGP_1X_out	t_{BUF}, t_{EN}, t_{DIS}	Using AGP-1X standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
SSTL3_I_out	t_{BUF}, t_{EN}, t_{DIS}	Using SSTL3_I standard	—	-0.25	—	-0.25	—	-0.25	—	-0.25	ns
SSTL3_II_out	t_{BUF}, t_{EN}, t_{DIS}	Using SSTL3_II standard	—	-0.35	—	-0.35	—	-0.35	—	-0.35	ns
SSTL2_I_out	t_{BUF}, t_{EN}, t_{DIS}	Using SSTL2_I standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
SSTL2_II_out	t_{BUF}, t_{EN}, t_{DIS}	Using SSTL2_II standard	—	-0.25	—	-0.25	—	-0.25	—	-0.25	ns
CTT33_out	t_{BUF}, t_{EN}, t_{DIS}	Using CCT3.3 standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
CTT25_out	t_{BUF}, t_{EN}, t_{DIS}	Using CCT2.5 standard	—	0.25	—	0.25	—	0.25	—	0.25	ns
HSTL_I_out	t_{BUF}, t_{EN}, t_{DIS}	Using HSTL_I standard	—	-0.30	—	-0.30	—	-0.30	—	-0.30	ns

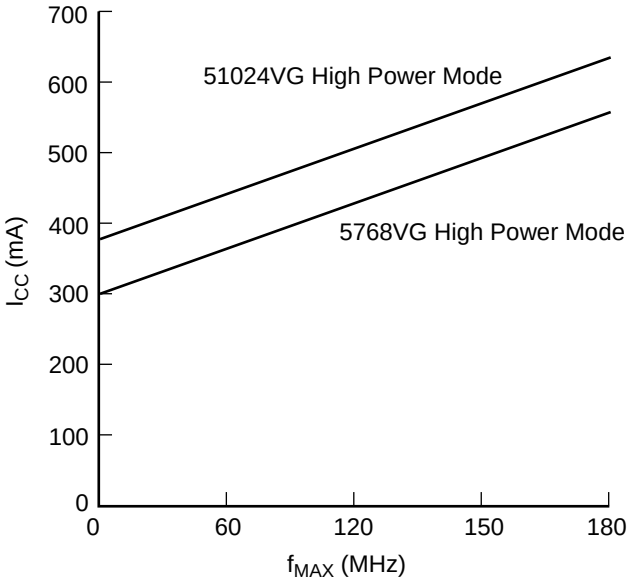
Note: Open drain timing is the same as corresponding LVCMOS timing.

Timing v.1.20

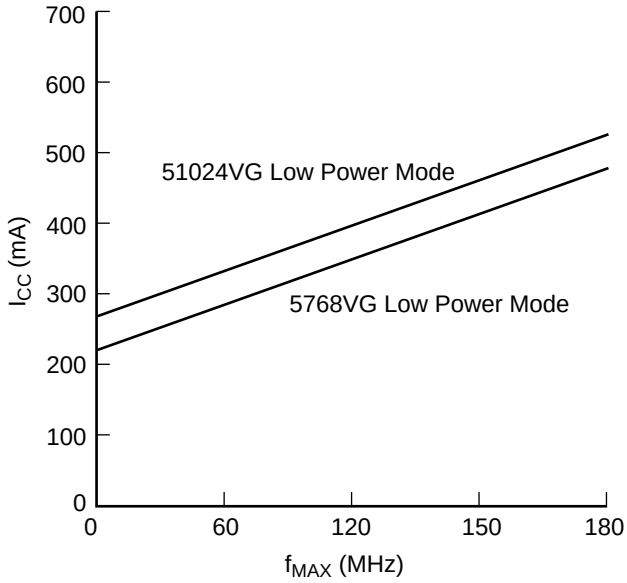
Power Consumption

ispMACH 5000VG Typical Power vs. Frequency

ispMACH 5000VG I_{CC} Curves at High Power Mode



ispMACH 5000VG I_{CC} Curves at Low Power Mode



Note: The devices are configured with maximum number of 16-bit counters, no PLL, typical current at 3.3V, 25° C.

Power Estimation Coefficients

Device	K0	K1	K2	K3	K4	K5	K6	I_{DC} (mA)	I_{DCO} (mA)
ispMACH 5768VG	0.0014	0.0014	0.054	1.5	0.152	0.105	5.0	65	20
ispMACH 51024VG	0.0014	0.0014	0.054	1.5	0.152	0.105	5.0	80	20

Note: For further information about the use of these coefficients, refer to Technical Note TN1002, *Power Estimation in ispMACH 5000VG Devices*.

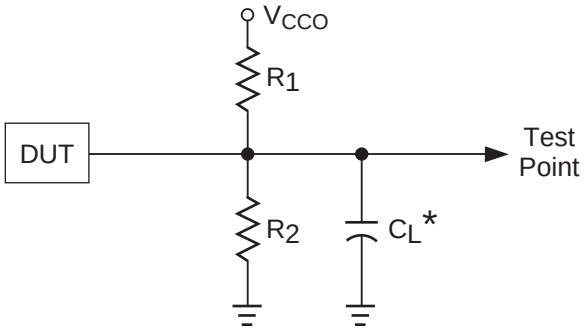
K0 = average current per product term in high power/MHz
K1 = average current per product term in low power/MHz
K2 = average current per GRP line/MHz
K3 = average current per PLL/MHz
K4 = DC current per product terms in high power
K5 = DC current per product terms in low power
K6 = Static DC current per PLL
I_{DC} = Static device current with all product terms powered off
I_{DCO} = Static I/O bank current

Icc estimates are based on typical conditions (Vcc = 3.3V, room temperature) and an assumption of one GLB load on average exists. These values are for estimates only. Since the value of Icc is sensitive to operating conditions and the program in the device, the actual Icc should be verified.

Switching Test Conditions

Figure 12 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 3.

Figure 12. Output Test Load, LVTTL and LVCMOS Standards



*C_L includes Test Fixture and Probe Capacitance.

0213A/ispm5kvg

Table 3. Test Fixture Required Components

Test Condition	R_1	R_2	C_L	Timing Ref.	V_{CCO}
Default LVCMOS 3.3 I/O (L -> H, H -> L)	110	110	35pF	1.5	3.0V
Other LVCMOS Settings, (L -> H, H -> L)	∞	∞	35pF	LVCMOS 3.3 = 1.5V	LVCMOS 3.3 = 3.0V
				LVCMOS 2.5 = V_{CCO}/2	LVCMOS 2.5 = 2.3V
				LVCMOS 1.8 = V_{CCO}/2	LVCMOS 1.8 = 1.65V
Default LVCMOS 3.3 I/O (Z -> H)	∞	110	35pF	1.5V	3.0V
Default LVCMOS 3.3 I/O (Z -> L)	110	∞	35pF	1.5V	3.0V
Default LVCMOS 3.3 I/O (H -> Z)	∞	110	5pF	V_{OH} - 0.3	3.0V
Default LVCMOS 3.3 I/O (L -> Z)	110	∞	5pF	V_{OL} + 0.3	3.0V

Output test conditions for all other interfaces are determined by the respective standards. For further details, please refer to the following technical note:

- *ispMACH 5000VG sysIO Design and Usage Guidelines* (TN1000)

Signal Descriptions

Signal Names	Description
TMS	Input - This pin is the Test Mode Select input, which is used to control the 1149.1 state machine.
TCK	Input - This pin is the Test Clock input pin, used to clock the 1149.1 state machine.
TDI	Input - This pin is the 1149.1 Test Data In pin, used to load data.
TDO	Output - This pin is the 1149.1 Test Data Out pin used to shift data out.
TOE	Input - Test Output Enable pin. TOE tristates all I/O pins when a logic low is driven.
GOE0, GOE1	Input - These two pins are the Global Output Enable input pins.
RESETB	Dedicated Reset Input - This pin resets all registers in the devices. The global polarity (active high or low input) for this pin is selectable.
xyzz (e.g. 0A16)	Input/Output - These are the general purpose I/O used by the logic array. *x* is segment reference (numeric), *y* is GLB reference (alpha) and *z* is macrocell reference (numeric). *x*: 0-7 (1024) *x*: 0-5 (768) *y*: A-D *z*: 0-31
GND	Ground
NC	No connect
V_{CC}	Vcc - These are the power supply pins for the logic core.
GCLK0, GCLK3	Input - These pins are configured to be either dedicated CLK input or PLL input.
GCLK1, GCLK2	Input - These pins are dedicated CLK input.
CLK_OUT0, CLK_OUT1	Output - These pins are the PLL output pins.
PLL_RST0, PLL_RST1	Input - These pins are for resetting the PLL, input clock (M) divider.
VREF0, VREF1, VREF2, VREF3	Input - These are the reference supplies for the I/O banks.
PLL_FBK0, PLL_FBK1	Input - These PLL feedback inputs allow optional external PLL feedback.
V_{CCP0}, V_{CCP1}	V_{CC} - These are the V_{CC} supplies for the PLLs.
V_{CCO0}, V_{CCO1}, V_{CCO2}, V_{CCO3}	V_{CC} - These are the V_{CC} supplies for each I/O bank.
GNDP0, GNDP1	GND - These are the separate ground connections for the PLLs.
V_{CCJ}	V_{CC} - This pin is for the 1149.1 test access port.

Note: For above, signal CLK_OUT0 connects to PLL0, and signal CLK_OUT1 connects to PLL1.

ispMACH 51024 Power Supply and NC Connections[1]

Signal	484-Ball fpBGA[2]	676-Ball fpBGA[2]
V_{CC}	B17, B2, B21, B6, C14, C9, E18, E5, F2, F21, J20, J3, P20, P3, U2, U21, Y14, Y9, AA17, AA2, AA21, AA6	B29, D6, D10, D12, D19, D21, D25, F4, F27, K4, K27, M4, M27, W4, W27, AA4, AA27, AE4, AE27, AG6, AG10, AG12, AG19, AG21,AG25, AJ2
V_{CCO0}	B5, D7, E2, E6, E9, F5, G4, J5	E5, E7, E9, E11, F10, G5, J5, K6, L5
V_{CCO1}	P5, U5, V6, V9, Y3	Y5, AA6, AB5, AD5, AE10, AF5, AF7, AF9, AF11
V_{CCO2}	P18, U18, V14, V17, Y20	Y26, AA25, AB26, AD26, AE21, AF20, AF22, AF24, AF26
V_{CCO3}	B18, D16, E14, E17, E21, F18, G19, J18	E20, E22, E24, E26, F21, G26, J26, K25, L26
V_{CCP0}	L7	P5
V_{CCP1}	N18	N26
V_{CCJ}	P4	U6
V_{REF0}	A9	C11
V_{REF1}	AA10	AK10
V_{REF2}	AA13	AJ21
V_{REF3}	A15	E19
GND PLL 0	L6	R6
GND PLL 1	L16	P25
GND	A1, A22, C3, C20, D4, D19, E7, E16, G5, G7, G8, G9, G10, G11, G12, G13, G14, G15, G16, G18, H7, H8, H9, H10, H11, H12, H13, H14, H15, H16, J7, J8, J9, J10, J11, J12, J13, J14, J15, J16, K7, K8, K9, K10, K11, K12, K13, K14, K15, K16, L8, L9, L10, L11, L12, L13, L14, L15, M7, M8, M9, M10, M11, M12, M13, M14, M15, M16, N7, N8, N9, N10, N11, N12, N13, N14, N15, N16, P7, P8, P9, P10, P11, P12, P13, P14, P15, P16, R7, R8, R9, R10, R11, R12, R13, R14, R15, R16, T4, T7, T8, T9, T10, T11, T12, T13, T14, T15, T16, T19, W7, W16, AB1, AB22	A1, A30, B2,C3, C28, D8, D23, F7, F9, F11, F12, F19, F20, F22, F24, G6, G25, H4, H27, J6, J25, L6, L11, L12, L13, L14, L15, L16, L17, L18, L19, L20, L25, M6, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, M25, N11, N12, N13, N14, N15, N16, N17, N18, N19, N20, P11, P12, P13, P14, P15, P16, P17, P18, P19, P20, R11, R12, R13, R14, R15, R16, R17, R18, R19, R20, T11, T12, T13, T14, T15, T16, T17, T18, T19, T20, U11, U12, U13, U14,U15, U16, U17, U18, U19, U20, V11, V12, V13, V14, V15, V16, V17, V18, V19, V20, W6, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, W25, Y6, Y11, Y12, Y13, Y14, Y15, Y16, Y17, Y18, Y19, Y20, Y25, AB6, AB25, AC4, AC27, AD6, AD25, AE7, AE9, AE11, AE12, AE19, AE20, AE22, AE24, AG8, AG23, AH3, AH28, AK1, AK30
NC[3]	AA1	A14, A15, A16, A17, B14, B15, B16, B17, C13, C14, C15, C16, C17, C18, D13, D14, D15, D16, D17, D18, E13, E14, E15, E16, E17, E18, F13, F14, F15, F16, F17, F18, AE13, AE14, AE15, AE16, AE17, AE18, AF13, AF14, AF15, AF16, AF17, AF18, AG13, AG14, AG15, AG16, AG17, AG18, AH14, AH15, AH16, AH17, AH18, AJ14, AJ15, AJ16, AJ17, AJ18, AK14, AK15, AK16, AK17

1. All grounds must be electrically connected at the board level.
2. Not all grounds internally connected within the device.
3. NC pins are not to be connected to any active signals, VCC or GND.

ispMACH 5768VG Logic Signal Connections

Bank No.	Signal	256 fpBGA	484 fpBGA
0	0C-30	C8	D11
0	0C-28	B6	B11
0	0C-26	A5	E12
0	0C-24	D8	C11
0	0C-22	E8	F12
0	0C-20	B5	B10
0	GNDIO0	GND	GND
0	0C-18	A4	A10
0	0C-16	D7	D10
0	0C-14/VREF0	E7	A9
0	0C-12	C6	E11
0	0C-10	B4	B9
0	0C-8	A3	F11
0	0C-6	NC	A8
0	0C-4	NC	C10
0	0C-2	NC	A7
0	0C-0	NC	E10
0	0D-30	NC	B8
0	0D-28	NC	C8
0	GNDIO0	GND	GND
0	0D-26	NC	F10
0	0D-24	NC	A6
0	0D-22	NC	F9
0	0D-20	NC	C7
0	0D-18	NC	D9
0	0D-16	NC	B7
0	0D-14	D6	E8
0	0D-12	E6	A5
0	0D-10	A2	F8
0	0D-8	B3	C6
0	0D-6	C4	D8
0	0D-4	D5	A3
0	GNDIO0	GND	GND
0	0D-2	NC	A2
0	0D-0	NC	A4
0	0A-0	NC	F7
0	0A-2	NC	C5
0	0A-4	NC	F6
0	0A-6	NC	B3
0	0A-8	NC	NC
0	0A-10	NC	NC
0	GNDIO0	GND	GND
0	0A-12	NC	NC

Bank No.	Signal	256 fpBGA	484 fpBGA
0	0A-14	NC	NC
0	0A-16	NC	B4
0	0A-18	NC	D5
0	0A-20	NC	B1
0	0A-22	NC	D6
0	0A-24	NC	C4
0	0A-26	NC	E4
0	GNDIO0	GND	GND
0	0A-28	B2	C2
0	0A-30	B1	C1
0	0B-30	C2	D1
0	0B-28	C1	D2
0	0B-26	NC	D3
0	0B-24	NC	E1
0	0B-22	NC	E3
0	0B-20	NC	F4
0	0B-18	NC	F1
0	0B-16	NC	F3
0	0B-14	NC	G6
0	0B-12	NC	G1
0	GNDIO0	GND	GND
0	0B-10	NC	G2
0	0B-8	NC	H1
0	0B-6	NC	G3
0	0B-4	NC	H2
0	0B-2	NC	H5
0	0B-0	NC	H6
0	1A-0	F7	J1
0	1A-2	F6	K1
0	1A-4	E5	H3
0	1A-6	D4	J2
0	1A-8	D3	H4
0	1A-10	D2	K2
0	GNDIO0	GND	GND
0	1A-12	D1	J6
0	1A-14	E4	L1
0	1A-16	NC	K3
0	1A-18	NC	J4
0	1A-20	NC	L2
0	1A-22	NC	M1
0	1A-24	NC	K6
0	1A-26	NC	K4
0	1A-28	NC	L3

ispMACH 5768VG Logic Signal Connections (Continued)

Bank No.	Signal	256 fpBGA	484 fpBGA
3	4B-24	G11	M19
3	4B-26	F11	M21
3	4B-28	F10	L19
3	4B-30/CLK_OUT1	B11	L20
3	GNDIO3	GND	GND
3	4A-30	NC	M17
3	4A-28	NC	M22
3	4A-26	NC	K20
3	4A-24	NC	L18
3	4A-22	NC	L21
3	4A-20	NC	K19
3	4A-18	NC	L22
3	4A-16	NC	K17
3	4A-14	E13	K22
3	4A-12	B12	L17
3	GNDIO3	GND	GND
3	4A-10	E15	K21
3	4A-8	D15	K18
3	4A-6	NC	J17
3	4A-4	NC	J19
3	4A-2	D16	J22
3	4A-0	E12	J21
3	5B-0	NC	H19
3	5B-2	NC	H20
3	5B-4	NC	H17
3	5B-6	NC	H18
3	5B-8	NC	H22
3	5B-10	NC	H21
3	GNDIO3	GND	GND
3	5B-12	NC	G20
3	5B-14	NC	G22
3	5B-16	NC	G17
3	5B-18	NC	G21
3	5B-20	NC	F19
3	5B-22	NC	F20
3	5B-24	A16	F22
3	5B-26	B15	E22
3	5B-28	A15	E19
3	5B-30	D13	E20
3	5A-30	B14	D22
3	5A-28	B16	D21
3	GNDIO3	GND	GND
3	5A-26	C16	D20

Bank No.	Signal	256 fpBGA	484 fpBGA
3	5A-24	C15	C22
3	5A-22	D14	C18
3	5A-20	A14	C19
3	5A-18	C13	D17
3	5A-16	B13	C21
3	5A-14	NC	NC
3	5A-12	NC	NC
3	GNDIO3	GND	GND
3	5A-10	NC	NC
3	5A-8	NC	NC
3	5A-6	NC	B22
3	5A-4	NC	D18
3	5A-2	NC	B20
3	5A-0	NC	F17
3	5D-0	NC	B19
3	5D-2	NC	C17
3	GNDIO3	GND	GND
3	5D-4	NC	A21
3	5D-6	NC	D15
3	5D-8	NC	A20
3	5D-10	NC	C16
3	5D-12	NC	A19
3	5D-14	NC	F16
3	5D-16	NC	B16
3	5D-18	NC	D14
3	5D-20	NC	A18
3	5D-22	A13	F15
3	5D-24	A12	A17
3	5D-26	A11	B15
3	GNDIO3	GND	GND
3	5D-28	A10	A16
3	5D-30	C11	F14
3	5C-0	A9	C15
3	5C-2	D12	D13
3	5C-4	D11	E15
3	5C-6	B10	F13
3	5C-8	B9	B14
3	5C-10	E11	E13
3	5C-12/VREF3	A8	A15
3	5C-14	D10	D12
3	5C-16	E10	A14
3	5C-18	A7	B13
3	GNDIO3	GND	GND

ispMACH 5768VG Logic Signal Connections (Continued)

Bank No.	Signal	256 fpBGA	484 fpBGA
3	5C-20	C9	A13
3	5C-22	E9	B12
3	5C-24	D9	C13
3	5C-26	B8	A12
3	5C-28	A6	C12
3	5C-30	B7	A11
—	GCLK0	H4	P6
—	GCLK1	J4	R6
—	GCLK2	H14	P17
—	GCLK3	H13	P19
—	GOE0	J15	R18
—	GOE1	H15	R17
—	RESETB	J14	R19
—	TCK	J3	R3
—	TDI	H3	R2
—	TDO	J2	R4
—	TMS	H2	T1
—	TOE	J13	T18

ispMACH 51024VG Logic Signal Connections (Continued)

Bank No.	Signal	484 fpBGA	676 fpBGA
2	4A-24	Y19	AE25
2	4A-26	V19	AG28
2	GNDIO2	GND	GND
2	4A-28	Y21	AF27
2	4A-30	W20	AE26
2	4B-30	AA22	AH30
2	4B-28	W21	AG29
2	4B-26	Y22	AF28
2	4B-24	V20	AG30
2	4B-22	V21	AF29
2	4B-20	W22	AC25
2	4B-18	V18	AE28
2	4B-16	U20	AF30
2	4B-14	V22	AD27
2	4B-12	U19	AE29
2	GNDIO2	GND	GND
2	4B-10	U17	AC26
2	4B-8	U22	AD28
2	4B-6	T20	AE30
2	4B-4	T21	AD29
2	4B-2	T17	AC28
2	4B-0	R20	AD30
2	5A-0	NC	AC29
2	5A-2	NC	AB27
2	5A-4	NC	AC30
2	5A-6	NC	AB28
2	5A-8	NC	AA26
2	5A-10	NC	AB29
2	GNDIO2	GND	GND
2	5A-12	NC	AB30
2	5A-14	NC	AA28
2	5A-16	NC	AA29
2	5A-18	NC	AA30
2	5A-20	NC	Y27
2	5A-22	NC	Y28
2	5A-24	NC	Y29
2	5A-26	NC	W26
2	5A-28	NC	Y30
2	5A-30	NC	W28
2	GNDIO2	GND	GND
2	5B-30	NC	W29
2	5B-28	NC	W30
2	5B-26	NC	V25

Bank No.	Signal	484 fpBGA	676 fpBGA
2	5B-24	NC	V26
2	5B-22	NC	V27
2	5B-20	NC	V28
2	5B-18	NC	V29
2	5B-16	NC	V30
2	5B-14	NC	U25
2	5B-12	NC	U27
2	GNDIO2	GND	GND
2	5B-10	NC	U28
2	5B-8	NC	U29
2	5B-6	NC	U30
2	5B-4	NC	T27
2	5B-2	NC	T28
2	5B-0	NC	T29
3	6B-0	R21	T30
3	6B-2	T22	R29
3	6B4/PLL_FBK1	P21	R27
3	6B6/PLL_RST1	N20	R28
3	6B-8	R22	R30
3	6B-10	N21	P30
3	GNDIO3	GND	GND
3	6B-12	M18	P29
3	6B-14	N19	P28
3	6B-16	P22	P27
3	6B-18	M20	N30
3	6B-20	N22	N29
3	6B-22	N17	N28
3	6B-24	M19	N27
3	6B-26	M21	N25
3	6B-28	L19	M30
3	6B-30/CLK_OUT1	L20	M29
3	GNDIO3	GND	GND
3	6A-30	M17	M28
3	6A-28	M22	L30
3	6A-26	K20	M26
3	6A-24	L18	L29
3	6A-22	L21	L28
3	6A-20	K19	L27
3	6A-18	L22	K30
3	6A-16	K17	K29
3	6A-14	K22	K28
3	6A-12	L17	J30
3	GNDIO3	GND	GND

ispMACH 51024VG Logic Signal Connections (Continued)

Bank No.	Signal	484 fpBGA	676 fpBGA
3	6A-10	K21	J29
3	6A-8	K18	K26
3	6A-6	J17	J28
3	6A-4	J19	H30
3	6A-2	J22	J27
3	6A-0	J21	H29
3	7B-0	H19	G30
3	7B-2	H20	H28
3	7B-4	H17	G29
3	7B-6	H18	F30
3	7B-8	H22	G28
3	7B-10	H21	H26
3	GNDIO3	GND	GND
3	7B-12	G20	F29
3	7B-14	G22	G27
3	7B-16	G17	E30
3	7B-18	G21	F28
3	7B-20	F19	H25
3	7B-22	F20	E29
3	7B-24	F22	D30
3	7B-26	E22	E28
3	7B-28	E19	D29
3	7B-30	E20	C30
3	7A-30	D22	F26
3	7A-28	D21	E27
3	GNDIO3	GND	GND
3	7A-26	D20	D28
3	7A-24	C22	F25
3	7A-22	C18	C29
3	7A-20	C19	B30
3	7A-18	D17	D27
3	7A-16	C21	E25
3	7A-14	NC	D26
3	7A-12	NC	C27
3	GNDIO3	GND	GND
3	7A-10	NC	B28
3	7A-8	NC	A29
3	7A-6	B22	F23
3	7A-4	D18	C26
3	7A-2	B20	B27
3	7A-0	F17	A28
3	7D-0	B19	A27
3	7D-2	C17	B26

Bank No.	Signal	484 fpBGA	676 fpBGA
3	GNDIO3	GND	GND
3	7D-4	A21	E23
3	7D-6	D15	D24
3	7D-8	A20	C25
3	7D-10	C16	A26
3	7D-12	A19	B25
3	7D-14	F16	C24
3	7D-16	B16	A25
3	7D-18	D14	B24
3	7D-20	A18	C23
3	7D-22	F15	D22
3	7D-24	A17	A24
3	7D-26	B15	E21
3	GNDIO3	GND	GND
3	7D-28	A16	B23
3	7D-30	F14	C22
3	7C-0	C15	A23
3	7C-2	D13	B22
3	7C-4	E15	C21
3	7C-6	F13	A22
3	7C-8	B14	D20
3	7C-10	E13	B21
3	7C-12/VREF3	A15	E19
3	7C-14	D12	C20
3	7C-16	A14	A21
3	7C-18	B13	B20
3	GNDIO3	GND	GND
3	7C-20	A13	A20
3	7C-22	B12	C19
3	7C-24	C13	B19
3	7C-26	A12	A19
3	7C-28	C12	B18
3	7C-30	A11	A18
—	GCLK0	P6	R5
—	GCLK1	R6	T6
—	GCLK2	P17	R25
—	GCLK3	P19	P26
—	GOE0	R18	T26
—	GOE1	R17	R26
—	RESETB	R19	T25
—	TCK	R3	U5
—	TDI	R2	T5
—	TDO	R4	V5

Signal Configuration

ispMACH 5768VG 256-ball fpBGA

	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	
A	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O/ VREF3	I/O	I/O	I/O	I/O	I/O	I/O	GND	A
B	I/O	I/O	I/O	I/O	I/O	I/O/ CLK_OUT1	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	B
C	I/O	I/O	VCCO3	I/O	GND	I/O	VCCO3	I/O	I/O	VCCO0	I/O	GND	I/O	VCCO0	I/O	I/O	C
D	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	D
E	I/O	I/O	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O/ VREF0	I/O	I/O	I/O	GND	I/O	I/O	E
F	I/O	I/O	I/O	I/O	I/O	I/O	I/O	VCC	VCC	I/O	I/O	I/O	I/O	I/O	I/O	I/O/ PLL_RST0	F
G	I/O	I/O/ PLL_FBK1	VCCO3	I/O	I/O	I/O	GND	GND	GND	GND	I/O/ CLK_OUT0	I/O	I/O	VCCO0	I/O/ PLL_FBK0	I/O	G
H	VCCP1	GOE1	GCLK2	GCLK3	I/O/ PLL_RST1	VCC	GND	GND	GND	GNDP0	VCC	I/O	GCLK0	TDI	TMS	VCCP0	H
J	I/O	GOE0	RESETB	TOE	I/O	VCC	GNDP1	GND	GND	GND	VCC	I/O	GCLK1	TCK	TDO	VCCJ	J
K	I/O	I/O	VCCO2	I/O	I/O	I/O	GND	GND	GND	GND	I/O	I/O	I/O	VCCO1	I/O	I/O	K
L	I/O	I/O	I/O	I/O	I/O	I/O	I/O	VCC	VCC	I/O	I/O	I/O	I/O	I/O	I/O	I/O	L
M	I/O	I/O	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O/ VREF1	I/O	I/O	I/O	GND	I/O	I/O	M
N	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	N
P	I/O	I/O	VCCO2	I/O	GND	I/O	VCCO2	I/O	I/O	VCCO1	I/O	GND	I/O	VCCO1	I/O	I/O	P
R	I/O	I/O	I/O	I/O/ VREF2	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	R
T	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	T
	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	

ispMACH 5768VG

256fpBGA/5768VG

Bottom View

Note: Ball A1 indicator dot on top side of package.

Signal Configuration

ispMACH 5768VG and 51024VG 484-ball fpBGA

	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	
A	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O / VREF3	I/O	I/O	I/O	I/O	I/O	I/O/ VREF0	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	**A**
B	I/O	VCC	I/O	I/O	VCCO3	VCC	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	VCC	VCCO0	I/O	I/O	VCC	I/O	**B**
C	I/O	I/O	GND	I/O	I/O	I/O	I/O	I/O	VCC	I/O	I/O	I/O	I/O	VCC	I/O	I/O	I/O	I/O	I/O	GND	I/O	I/O	**C**
D	I/O	I/O	I/O	GND	I/O	I/O	VCCO3	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	VCCO0	I/O	I/O	GND	I/O	I/O	I/O	**D**
E	I/O	VCCO3	I/O	I/O	VCC	VCCO3	GND	I/O	VCCO3	I/O	I/O	I/O	I/O	VCCO0	I/O	GND	VCCO0	VCC	I/O	I/O	VCCO0	I/O	**E**
F	I/O	VCC	I/O	I/O	VCCO3	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	VCCO0	I/O	I/O	VCC	I/O	**F**
G	I/O	I/O	I/O	VCCO3	GND	I/O	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	I/O	GND	VCCO0	I/O	I/O	I/O	**G**
H	I/O	I/O	I/O	I/O	I/O	I/O	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	I/O	I/O	I/O	I/O	I/O	I/O	**H**
J	I/O	I/O	VCC	I/O	VCCO3	I/O	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	I/O	VCCO0	I/O	VCC	I/O	I/O	**J**
K	I/O	I/O	I/O	I/O	I/O	I/O	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	I/O	I/O	I/O	I/O	I/O	I/O	**K**
L	I/O	I/O	I/O/ CLK_OUT1	I/O	I/O	I/O	GNDP1	GND	GND	GND	GND	GND	GND	GND	GND	VCCP0	GNDP0	I/O	I/O	I/O	I/O	I/O	**L**
M	I/O	I/O	I/O	I/O	I/O	I/O	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	I/O	I/O	I/O/ PLL_RST0	I/O	I/O	I/O	**M**
N	I/O	I/O	I/O/ PLL_RST1	I/O	VCCP1	I/O	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	I/O	I/O	I/O/ PLL_FBK0	I/O	I/O	I/O/ CLK_OUT0	**N**
P	I/O	I/O/ PLL_FBK1	VCC	GCLK3	VCCO2	GCLK2	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GCLK0	VCCO1	VCCJ	VCC	I/O	I/O	**P**
R	I/O	I/O	I/O	RESETB	GOE0	GOE1	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GCLK1	I/O	TDO	TCK	TDI	I/O	**R**
T	I/O	I/O	I/O	GND	TOE	I/O	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	I/O	I/O	GND	I/O	I/O	TMS	**T**
U	I/O	VCC	I/O	I/O	VCCO2	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	VCCO1	I/O	I/O	VCC	I/O	**U**
V	I/O	I/O	I/O	I/O	I/O	VCCO2	I/O	I/O	VCCO2	I/O	I/O	I/O	I/O	VCCO1	I/O	I/O	VCCO1	I/O	I/O	I/O	I/O	I/O	**V**
W	I/O	I/O	I/O	I/O	I/O	I/O	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	I/O	I/O	I/O	I/O	I/O	I/O	**W**
Y	I/O	I/O	VCCO2	I/O	I/O	I/O	I/O	I/O	VCC	I/O	I/O	I/O	I/O	VCC	I/O	I/O	I/O	I/O	I/O	VCCO1	I/O	I/O	**Y**
AA	I/O	VCC	I/O	I/O	I/O	VCC	I/O	I/O	I/O	I/O/ VREF2	I/O	I/O	I/O/ VREF1	I/O	I/O	I/O	VCC	I/O	I/O	I/O	VCC	NC[1]	**AA**
AB	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	**AB**
	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	

ispMACH 5768VG and 51024VG 484BGA/51024VG

Bottom View

1. NCs are not to be connected to any active signals, VCC or GND.

Note: Ball A1 indicator dot on top side of package.

Signal Configuration

ispMACH 51024VG 676-ball fpBGA

	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	
A	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC[1]	NC[1]	NC[1]	NC[1]	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	A
B	I/O	VCC	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC[1]	NC[1]	NC[1]	NC[1]	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	I/O	B
C	I/O	I/O	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	I/O	I/O/ VREF0	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	I/O	I/O	C
D	I/O	I/O	I/O	I/O	I/O	VCC	I/O	GND	I/O	VCC	I/O	VCC	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	VCC	I/O	VCC	I/O	GND	I/O	VCC	I/O	I/O	I/O	I/O	I/O	D
E	I/O	I/O	I/O	I/O	VCCO3	I/O	VCCO3	I/O	VCCO3	I/O	VCCO3	I/O/ VREF3	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	I/O	VCCO0	I/O	VCCO0	I/O	VCCO0	I/O	VCCO0	I/O	I/O	I/O	I/O	E
F	I/O	I/O	I/O	VCC	I/O	I/O	GND	I/O	GND	VCCO3	GND	GND	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	GND	GND	VCCO0	GND	I/O	GND	I/O	I/O	VCC	I/O	I/O	I/O	F
G	I/O	I/O	I/O	I/O	VCCO3	GND																			GND	VCCO0	I/O	I/O	I/O	I/O	G
H	I/O	I/O	I/O	GND	I/O	I/O																			I/O	I/O	GND	I/O	I/O	I/O	H
J	I/O	I/O	I/O	I/O	VCCO3	GND																			GND	VCCO0	I/O	I/O	I/O	I/O	J
K	I/O	I/O	I/O	VCC	I/O	VCCO3																			VCCO0	I/O	VCC	I/O	I/O	I/O	K
L	I/O	I/O	I/O	I/O	VCCO3	GND					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					GND	VCCO0	I/O	I/O	I/O	I/O	L
M	I/O	I/O/ CLK_OUT1	I/O	VCC	I/O	GND					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					GND	I/O	VCC	I/O	I/O/ CLK_OUT0	I/O	M
N	I/O	I/O	I/O	I/O	VCCP1	I/O					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					I/O	I/O	I/O	I/O	I/O	I/O	N
P	I/O	I/O	I/O	I/O	GCLK3	GNDP1					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					I/O	VCCP0	I/O	I/O	I/O	I/O/ PLL_RST0	P
R	I/O	I/O	I/O/ PLL_RST1	I/O/ PLL_FBK1	GOE1	GCLK2					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					GNDP0	GCLK0	I/O/ PLL_FBK0	I/O	I/O	I/O	R
T	I/O	I/O	I/O	I/O	GOE0	RESETB					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					GCLK1	TDI	TMS	I/O	I/O	I/O	T
U	I/O	I/O	I/O	I/O	TOE	I/O					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					VCCJ	TCK	I/O	I/O	I/O	I/O	U
V	I/O	I/O	I/O	I/O	I/O	I/O					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					I/O	TDO	I/O	I/O	I/O	I/O	V
W	I/O	I/O	I/O	VCC	I/O	GND					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					GND	I/O	VCC	I/O	I/O	I/O	W
Y	I/O	I/O	I/O	I/O	VCCO2	GND					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					GND	VCCO1	I/O	I/O	I/O	I/O	Y
AA	I/O	I/O	I/O	VCC	I/O	VCCO2																			VCCO1	I/O	VCC	I/O	I/O	I/O	AA
AB	I/O	I/O	I/O	I/O	VCCO2	GND																			GND	VCCO1	I/O	I/O	I/O	I/O	AB
AC	I/O	I/O	I/O	GND	I/O	I/O																			I/O	I/O	GND	I/O	I/O	I/O	AC
AD	I/O	I/O	I/O	I/O	VCCO2	GND																			GND	VCCO1	I/O	I/O	I/O	I/O	AD
AE	I/O	I/O	I/O	VCC	I/O	I/O	GND	I/O	GND	VCCO2	GND	GND	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	GND	GND	VCCO1	GND	I/O	GND	I/O	I/O	VCC	I/O	I/O	I/O	AE
AF	I/O	I/O	I/O	I/O	VCCO2	I/O	VCCO2	I/O	VCCO2	I/O	VCCO2	I/O	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	I/O	VCCO1	I/O	VCCO1	I/O	VCCO1	I/O	VCCO1	I/O	I/O	I/O	I/O	AF
AG	I/O	I/O	I/O	I/O	I/O	VCC	I/O	GND	I/O	VCC	I/O	VCC	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	VCC	I/O	VCC	I/O	GND	I/O	VCC	I/O	I/O	I/O	I/O	I/O	AG
AH	I/O	I/O	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	I/O	I/O	AH
AJ	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O/ VREF2	I/O	I/O	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	VCC	I/O	AJ
AK	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC[1]	NC[1]	NC[1]	NC[1]	I/O	I/O	I/O	I/O/ VREF1	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	AK
	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	

ispMACH 51024VG

Bottom View

676BGA/51024VG

1. NCs are not to be connected to any active signals, VCC or GND.

Note: Ball A1 indicator dot on top side of package.